

TVS5800 58V Flat-Clamp Surge Protection Device

1 Features

- IEC 61000-4-5 Surge Protection:
 - 25A (8/20 μ s)
 - Clamping voltage: 70.9V at 20A (8/20 μ s)
- Low leakage current:
 - 6nA typical at 27°C
 - 50nA typical at 85°C
- Low capacitance: 150pF
- Integrated IEC 61000-4-2 ESD protection

2 Applications

- Power over Ethernet (PoE)
- PLC I/O Modules
- Appliances
- Industrial Sensors
- Power lines

3 Description

The TVS5800 robustly shunts up to 25A of IEC 61000-4-5 fault current to protect systems from high power transients or lightning strikes. The TVS5800 uses a unique feedback mechanism to maintain precise flat clamping during a fault, supporting system exposure below 76V. The tight voltage regulation allows designers to confidently select system components with a lower voltage tolerance, lowering system costs and complexity without sacrificing robustness.

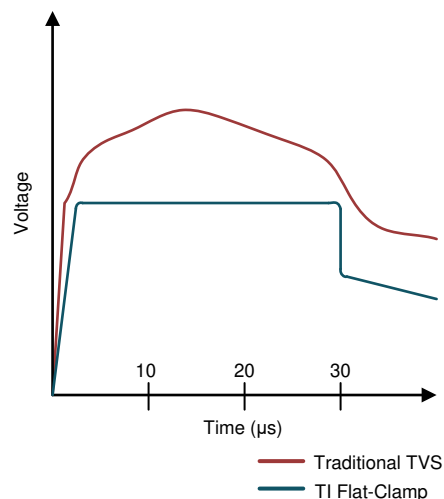
In addition, the TVS5800 is available in a 1.6mm x 1.6mm footprint which is designed for space constrained applications. The extremely low device leakage and capacitance allows a minimal effect on the protected line.

The TVS5800 is part of TI's Flat-Clamp family of surge devices. For more information on the other devices in the family, see the [Device Comparison Table](#)

Package Information

PART NUMBER	PACKAGE ⁽¹⁾	PACKAGE SIZE ⁽²⁾
TVS5800	VEB (DFN1616, 6)	1.6mm × 1.6mm

- (1) For more information, see the orderable addendum at the end of the data sheet.
- (2) The package size (length x width) is a nominal value and includes pins, where applicable.



Voltage Clamp Response to 8/20 μ s Surge Event



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4 Device Comparison Table

Device	V_{rwm} (V)	V_{clamp} at I_{pp} (V)	I_{pp} (8/20 μ s) (A)	V_{rwm} leakage (nA)	Package Options	Polarity
TVS0500	5	9.2	43	0.07	SON	Unidirectional
TVS1400	14	18.4	43	2	SON	Unidirectional
TVS1800	18	22.8	40	0.5	SON	Unidirectional
TVS2200	22	27.7	40	3.2	SON	Unidirectional
TVS2700	27	32.5	40	1.7	SON	Unidirectional
TVS3300	33	38	35	19	WCSP, SON	Unidirectional
TVS4000 ⁽¹⁾	40	50.4	24	4.45	DFN1616	Unidirectional
TVS5200 ⁽¹⁾	52	58.8	20	18.3	DFN1616	Unidirectional
TVS5800	58	70.9	25	6	DFN1616	Unidirectional

(1) Preview information (not Production Data)

5 Pin Configuration and Functions

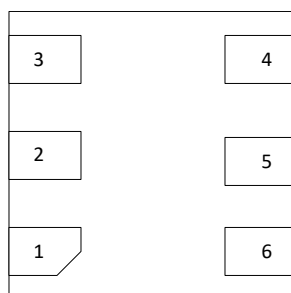


Figure 5-1. VEB Package, 6-Pin DFN1616 (Bottom View)

Table 5-1. Pin Functions

PIN		TYPE ⁽¹⁾	DESCRIPTION
NAME	NO.		
IN	4, 5, 6	I	ESD and surge protected channel
GND	1, 2, 3	GND	Ground

(1) I = input, GND = ground

6 Specifications

6.1 Absolute Maximum Ratings

$T_A = 27^\circ\text{C}$ (unless otherwise noted)⁽¹⁾

		MIN	MAX	UNIT
Maximum Surge	IEC 61000-4-5 Current (8/20 μs)		25	A
	IEC 61000-4-5 Power (8/20 μs)		1880	W
EFT	IEC 61000-4-4 EFT Protection		80	A
T_A	Ambient Operating Temperature	-40	125	$^\circ\text{C}$
T_{stg}	Storage Temperature	-65	150	$^\circ\text{C}$

- (1) Stresses beyond those listed under *Absolute Maximum Rating* may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Condition*. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

6.2 ESD Ratings - JEDEC

			VALUE	UNIT
$V_{\text{(ESD)}}$	Electrostatic discharge	Human body model (HBM), per ANSI/ESDA/JEDEC JS-001, all pins ⁽¹⁾	± 2000	V
		Charged device model (CDM), per JEDEC specification JESD22-C101, all pins ⁽²⁾	± 500	

- (1) JEDEC document JEP155 states that 500V HBM allows safe manufacturing with a standard ESD control process.

- (2) JEDEC document JEP157 states that 250V CDM allows safe manufacturing with a standard ESD control process.

6.3 ESD Ratings - IEC

			VALUE	UNIT
$V_{\text{(ESD)}}$	Electrostatic discharge	IEC 61000-4-2 contact discharge	± 15	kV
		IEC 61000-4-2 air-gap discharge	± 15	

6.4 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

	PARAMETER	MIN	NOM	MAX	UNIT
V_{RWM}	Reverse Stand-off Voltage			58	V

6.5 Thermal Information

THERMAL METRIC ⁽¹⁾		TVS5800	UNIT
		VEB (DFN1616)	
		6 PINS	
R _{θJA}	Junction-to-ambient thermal resistance	132.1	°C/W
R _{θJC(top)}	Junction-to-case (top) thermal resistance	61.5	°C/W
R _{θJB}	Junction-to-board thermal resistance	34.5	°C/W
Ψ _{JT}	Junction-to-top characterization parameter	1.04	°C/W
Ψ _{JB}	Junction-to-board characterization parameter	34.4	°C/W
R _{θJC(bot)}	Junction-to-case (bottom) thermal resistance	N/A	°C/W

- (1) For more information about traditional and new thermal metrics, see the [Semiconductor and IC Package Thermal Metrics](#) application note.

6.6 Electrical Characteristics

over operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
V_{RWM}	Reverse Stand-off Voltage		-0.5		58	V
I_{LEAK}	Leakage Current	Measured at $V_{IN} = V_{RWM}$ $T_A = 27^{\circ}\text{C}$		6	300	nA
		Measured at $V_{IN} = V_{RWM}$ $T_A = 85^{\circ}\text{C}$		50	1200	nA
		Measured at $V_{IN} = V_{RWM}$ $T_A = 105^{\circ}\text{C}$		140	2400	nA
V_F	Forward Voltage	$I_{IN} = 1\text{mA}$ from GND to IO	0.25	0.5	0.65	V
V_{BR}	Break-down Voltage	$I_{IN} = 1\text{mA}$ from IO to GND	65.8	69.8		V
V_{CLAMP}	Clamp Voltage	10A IEC 61000-4-5 Surge (8/20 μs) from IO to GND, $V_{IN} = 0\text{V}$ before surge, 27°C	66.5	70.7	74.7	V
		20A IEC 61000-4-5 Surge (8/20 μs) from IO to GND, $V_{IN} = 0\text{V}$ before surge, 27°C	66.7	70.9	75	V
R_{DYN}	8/20 μs surge dynamic resistance	Calculated from V_{CLAMP} at $.5 \cdot I_{pp}$ and I_{pp} surge current levels, 27°C		40		m Ω
C_{IN}	Input pin capacitance	$V_{IN} = V_{RWM}$, $f = 1\text{MHz}$, 30mV_{pp} , IO to GND		150		pF

6.7 Typical Characteristics

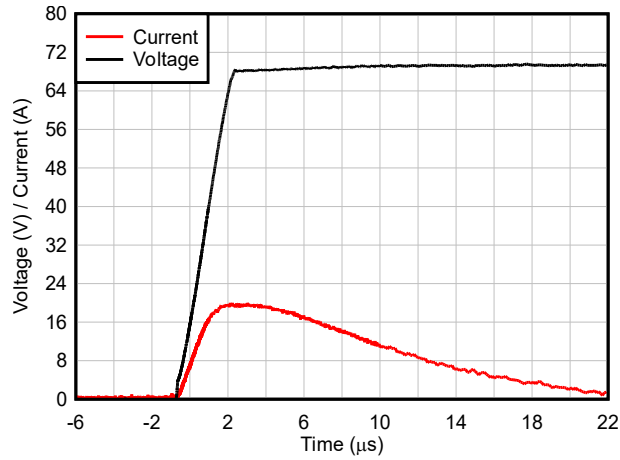


Figure 6-1. 8/20 μ s Surge Response at 20A

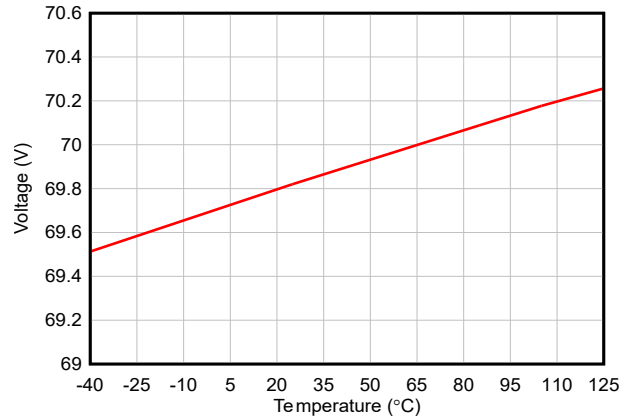


Figure 6-2. Breakdown Voltage (1mA) vs Temperature

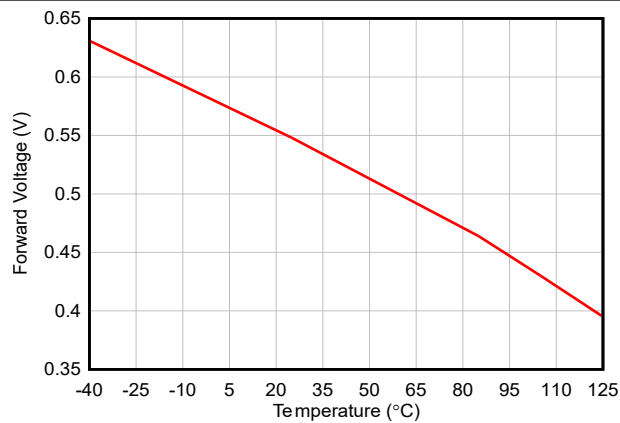


Figure 6-3. Forward Voltage vs Temperature

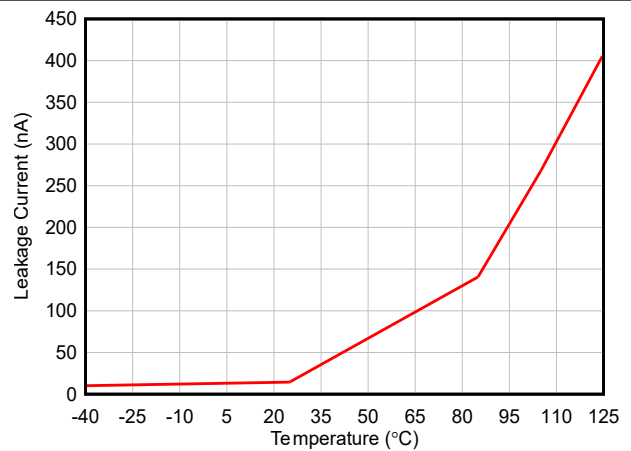


Figure 6-4. Leakage Current vs Temperature at 58V

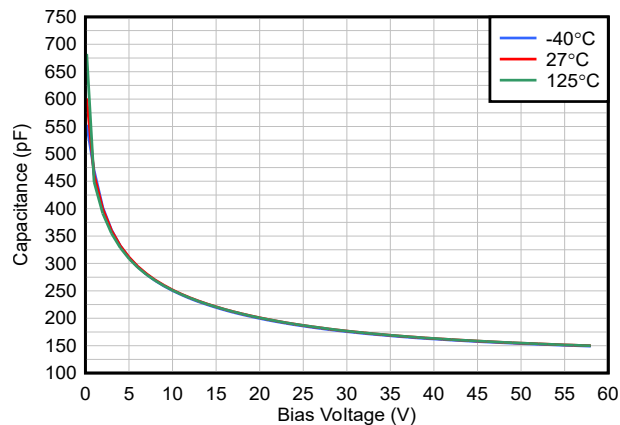


Figure 6-5. Capacitance vs Bias Voltage Across Temperature

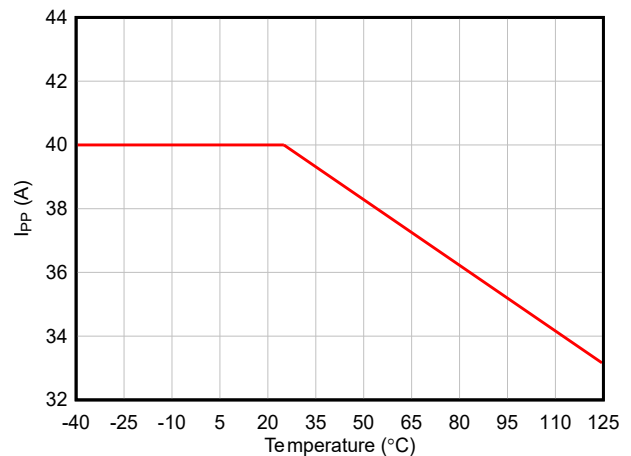


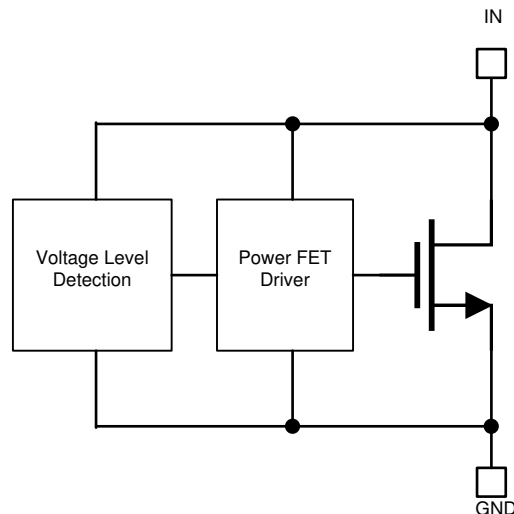
Figure 6-6. Max Surge Current (8/20 μ s) vs Temperature

7 Detailed Description

7.1 Overview

The TVS5800 is a precision clamp with a low, flat clamping voltage during transient overvoltage events like surge and protecting the system with zero voltage overshoot. For a detailed overview of the Flat-Clamp family of devices, please reference [TI's Flat-Clamp surge protection technology for efficient system protection](#) white paper. This document explains in detail the functional operation of the devices and how the TVS5800 impacts and improves system design.

7.2 Functional Block Diagram



7.3 Feature Description

The TVS5800 is a precision clamp that handles 25A of IEC 61000-4-5 8/20 μ s surge pulse. The flat clamping feature helps keep the clamping voltage very low to keep the downstream circuits from being stressed. The flat clamping feature can also help end-equipment designers save cost by opening up the possibility to use lower-cost, lower voltage tolerant downstream ICs. The TVS5800 has minimal leakage under the standoff voltage of 58V, making TVS5800 an desirable candidate for applications where low leakage and power dissipation is a necessity. IEC 61000-4-2 rating make TVS5800 a robust protection design for ESD events. Wide ambient temperature range of -40°C to +125°C, a good candidate for most applications. Compact package enables the TVS5800 to be used in small devices and save board area.

7.4 Device Functional Modes

7.4.1 Protection Specifications

The TVS5800 is specified according to the IEC 61000-4-5 standard. The IEC 61000-4-5 standards requires protection against a pulse with a rise time of 8 μ s and a half length of 20 μ s.

The TVS5800 has been tested according to IEC 61000-4-5 to pass a ± 1 kV surge test through a 42 Ω coupling resistor and a 0.5 μ F capacitor. This test is a common test requirement for industrial signal I/O lines and the TVS5800 serves as an desired protection design for applications with that requirement.

The TVS5800 also integrates IEC 61000-4-2 level 4 ESD Protection. These combine to maintain that the device can protect against most transient conditions regardless of length or type.

For more information on TI's test methods for Surge, ESD, and EFT testing, reference [TI's IEC 61000-4-x Testing Application Note](#)

8 Application and Implementation

Note

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes, as well as validating and testing their design implementation to confirm system functionality.

8.1 Application Information

The TVS5800 can be used to protect any power, analog, or digital signal from transient fault conditions caused by the environment or other electrical components.

8.2 Typical Application

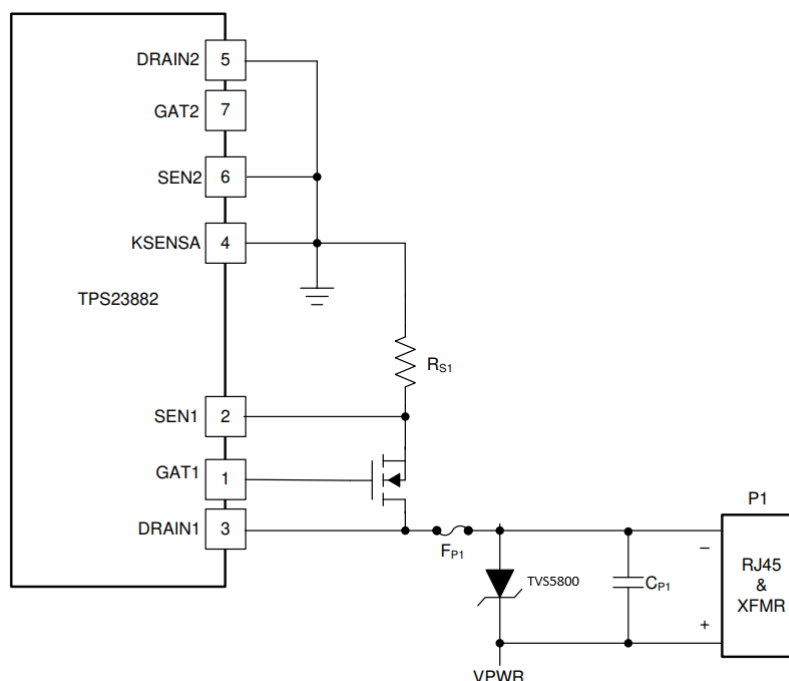


Figure 8-1. TVS5800 Application Schematic

8.2.1 Design Requirements

An application for the TVS5800 is protecting a Power over Ethernet (PoE) Power Sourcing Equipment (PSE) controller. In this example, the TVS5800 is protecting a PoE PSE controller such as the TPS23882, that has a nominal voltage of 58V and a clamping voltage requirement below 95V which is easily doable for the TVS5800 with a max clamping voltage of 75V. Most industrial interfaces such as this require protection against $\pm 1\text{kV}$ surge test through a 42Ω coupling resistor and a $0.5\mu\text{F}$ capacitor, equaling roughly 24A of surge current. Without any input protection, if a surge event is caused by lightning, coupling, ringing, or any other fault condition thisssd input voltage rises to hundreds of volts for multiple microseconds, violating the absolute maximum input voltage and harming the device. A desired surge protection diode maximizes the useable voltage range while still clamping at a safe level for the system, TI's Flat-Clamp technology provides the best protection design. For more information on PoE PSE controller protection, see Section 10.2 of the [TPS23882 data sheet](#).

8.2.2 Detailed Design Procedure

If the TVS5800 is in place to protect the device, during a surge event the voltage rises to the breakdown of the diode at 69.8V, and then the TVS5800 turns on, shunting the surge current to ground. With the low dynamic resistance of the TVS5800, large amounts of surge current has minimal impact on the clamping voltage. The dynamic resistance of the TVS5800 is around 40mΩ, which means 25A of surge current causes a voltage raise of $25A \times 40m\Omega = 1V$. Because the device turns on at 69.8V, this means the TPS23882 input is exposed to a maximum of $69.8V + 1V = 70.8V$ during surge pulses. This maintains robust protection of your circuit.

The small size of the device also improves fault protection by lowering the effect of fault current coupling onto neighboring traces. The small form factor of the TVS5800 allows the device to be placed extremely close to the input connector, lowering the length of the path fault current takes through the system compared to larger protection designs.

9 Power Supply Recommendations

The TVS5800 is a clamping device so there is no need to power the device. To maintain the device functions properly do not violate the recommended V_{IN} voltage range (0V to 58V) .

10 Layout

10.1 Layout Guidelines

The optimum placement is close to the connector. EMI during an ESD event can couple from the trace being struck to other nearby unprotected traces, resulting in early system failures. The PCB designer must minimize the possibility of EMI coupling by keeping any unprotected traces away from the protected traces which are between the TVS and the connector.

Route the protected traces straight. Eliminate any sharp corners on the protected traces between the TVS5800 and the connector by using rounded corners with the largest radii possible. Electric fields tend to build up on corners, increasing EMI coupling.

10.2 Layout Example

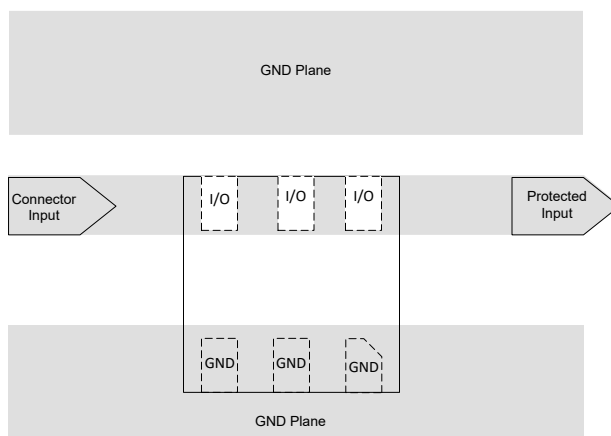


Figure 10-1. TVS5800 DFN1616 Layout

11 Device and Documentation Support

11.1 Documentation Support

11.1.1 Related Documentation

For related documentation, see the following:

- Texas Instruments, [Flat-Clamp TVS Evaluation Kit](#)
- Texas Instruments, [How to select a Surge Diode](#)
- Texas Instruments, [Flat-Clamp surge protection technology for efficient system protection](#)

11.2 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on ti.com. Click on *Notifications* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

11.3 Support Resources

TI E2E™ support forums are an engineer's go-to source for fast, verified answers and design help — straight from the experts. Search existing answers or ask your own question to get the quick design help you need.

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11.4 Trademarks

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11.5 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

11.6 Glossary

[TI Glossary](#) This glossary lists and explains terms, acronyms, and definitions.

12 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

DATE	REVISION	NOTES
January 2026	*	Initial Release

13 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
TVS5800VEBR	Active	Production	UQFN-HR (VEB) 6	3000 LARGE T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 125	S9

- (1) **Status:** For more details on status, see our [product life cycle](#).
- (2) **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.
- (3) **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.
- (4) **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.
- (5) **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.
- (6) **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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TAPE AND REEL INFORMATION



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TVS5800VEBR	UQFN-HR	VEB	6	3000	180.0	8.4	1.85	1.85	0.85	4.0	8.0	Q1

TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TVS5800VEBR	UQFN-HR	VEB	6	3000	210.0	185.0	35.0

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Last updated 10/2025